

MOSFET

OptiMOS[™] 6 Power-Transistor, 120 V

Features

- N-channel, normal level
- Very low on-resistance R_{DS(on)}
- Excellent gate charge x R_{DS(on)} product (FOM) Very low reverse recovery charge (Q_{rr})
- · High avalanche energy rating
- 175°C operating temperature
- Optimized for high frequency switching and synchronous rectification
 Pb-free lead plating; RoHS compliant
 Halogen-free according to IEC61249-2-21

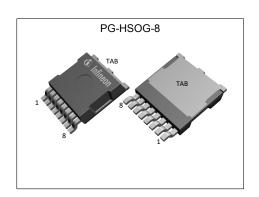
- MSL 1 classified according to J-STD-020

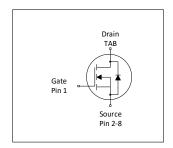


Fully qualified according to JEDEC for Industrial Applications

Table 1 **Key Performance Parameters**

Table 1 Roy 1 of formation 1 aramotoro							
Parameter	Value	Unit					
$V_{ t DS}$	120	V					
$R_{\mathrm{DS(on),max}}$	1.7	mΩ					
I _D	331	Α					
Qoss	266	nC					
Q _G (0V10V)	113	nC					
Q _{rr} (1000A/μs)	339.3	nC					











Type / Ordering Code	Package	Marking	Related Links
IPTG017N12NM6	PG-HSOG-8	017N12N6	-

OptiMOSTM 6 Power-Transistor, 120 V IPTG017N12NM6



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OptiMOS[™] 6 Power-Transistor, 120 V IPTG017N12NM6



1 Maximum ratings at T_A =25 °C, unless otherwise specified

Table 2 Maximum ratings

Davamatav	Suma bad		Value	s	11	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Continuous drain current ¹⁾	I _D	- - -	- - -	331 234 213 32	A	$V_{\rm GS}$ =10 V, $T_{\rm C}$ =25 °C $V_{\rm GS}$ =10 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =8 V, $T_{\rm C}$ =100 °C $V_{\rm GS}$ =10 V, $T_{\rm A}$ =25°C, $R_{\rm thJA}$ =40°C/W ²⁾
Pulsed drain current ³⁾	I _{D,pulse}	-	-	1324	Α	<i>T</i> _C =25 °C
Avalanche current, single pulse ⁴⁾	I _{AS}	-	-	150	Α	<i>T</i> _C =25 °C
Avalanche energy, single pulse ⁴⁾	E AS	-	-	1328	mJ	$I_{\rm D}$ =77 A, $R_{\rm GS}$ =25 Ω
Gate source voltage	V _{GS}	-20	-	20	V	-
Power dissipation	P _{tot}	-	-	395 3.8	W	T _C =25 °C T _A =25 °C, R _{thJA} =40 °C/W ²⁾
Operating and storage temperature	$T_{\rm j},~T_{\rm stg}$	-55	-	175	°C	-

2 Thermal characteristics

Table 3 Thermal characteristics

Parameter	Symbol	Values			l lmit	Note / Test Condition
raiailletei	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Thermal resistance, junction - case	R _{thJC}	-	-	0.38	°C/W	-
Thermal resistance, junction - ambient, 6 cm² cooling area²)	R _{thJA}	-	-	40	°C/W	-

¹⁾ Rating refers to the product only with datasheet specified absolute maximum values, maintaining case temperature as specified. For other case temperatures please refer to Diagram 2. De-rating will be required based on the actual environmental conditions.

2) Device on 40 mm x 40 mm x 1.5 mm epoxy PCB FR4 with 6 cm² (one layer, 70 µm thick) copper area for drain

connection. PCB is vertical in still air.

3) See Diagram 3 for more detailed information

4) See Diagram 13 for more detailed information

OptiMOS[™] 6 Power-Transistor, 120 V



3 Electrical characteristics

at T_j=25 °C, unless otherwise specified

Table 4 Static characteristics

Danagastan	Correction I		Values			
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Drain-source breakdown voltage	V _{(BR)DSS}	120	-	-	V	$V_{\rm GS}$ =0 V, $I_{\rm D}$ =1 mA
Gate threshold voltage	V _{GS(th)}	2.6	3.1	3.6	V	$V_{\rm DS}$ = $V_{\rm GS}$, $I_{\rm D}$ =275 μ A
Zero gate voltage drain current	I _{DSS}	-	0.1 10	1 100	μΑ	V _{DS} =100 V, V _{GS} =0 V, T _j =25 °C V _{DS} =100 V, V _{GS} =0 V, T _j =125 °C ¹⁾
Gate-source leakage current	I_{GSS}	-	10	100	nA	V _{GS} =20 V, V _{DS} =0 V
Drain-source on-state resistance	R _{DS(on)}	-	1.5 1.7	1.7 2.06	mΩ	V _{GS} =10 V, I _D =150 A V _{GS} =8 V, I _D =75 A
Gate resistance	R _G	0.55	1.1	1.65	Ω	-
Transconductance	g fs	125	250	-	S	$ V_{DS} \ge 2 I_D R_{DS(on)max}, I_D = 150 \text{ A}$

Table 5 Dynamic characteristics

Parameter	Cumbal	Values			11	Nata / Tank Candikian
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Input capacitance	Ciss	-	8100	11000	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Output capacitance ¹⁾	Coss	-	2400	3100	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Reverse transfer capacitance ¹⁾	C _{rss}	-	40	70	pF	V _{GS} =0 V, V _{DS} =60 V, <i>f</i> =1 MHz
Turn-on delay time	$t_{\sf d(on)}$	-	18.5	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Rise time	t _r	-	14.8	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Turn-off delay time	$t_{ m d(off)}$	-	37.1	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω
Fall time	t _f	-	19.8	-	ns	$V_{\rm DD}$ =60 V, $V_{\rm GS}$ =10 V, $I_{\rm D}$ =75 A, $R_{\rm G,ext}$ =1.6 Ω

Table 6 Gate charge characteristics²⁾

Doromotor	Cymbal	Values			11	Note / Took Condition
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Gate to source charge	Q _{gs}	-	41	53	nC	V_{DD} =60 V, I_{D} =75 A, V_{GS} =0 to 10 V
Gate charge at threshold	Q _{g(th)}	-	25	31	nC	V_{DD} =60 V, I_{D} =75 A, V_{GS} =0 to 10 V
Gate to drain charge ¹⁾	Q _{gd}	-	25	38	nC	V _{DD} =60 V, I _D =75 A, V _{GS} =0 to 10 V
Switching charge	Q _{sw}	-	40	-	nC	V _{DD} =60 V, I _D =75 A, V _{GS} =0 to 10 V
Gate charge total ¹⁾	Q g	-	113	141	nC	V _{DD} =60 V, I _D =75 A, V _{GS} =0 to 10 V
Gate plateau voltage	V _{plateau}	-	5.0	-	V	V_{DD} =60 V, I_{D} =75 A, V_{GS} =0 to 10 V
Output charge ¹⁾	Qoss	-	266	354	nC	V _{DS} =60 V, V _{GS} =0 V

 $^{^{1)}}$ Defined by design. Not subject to production test. $^{2)}$ See "Gate charge waveforms" for parameter definition

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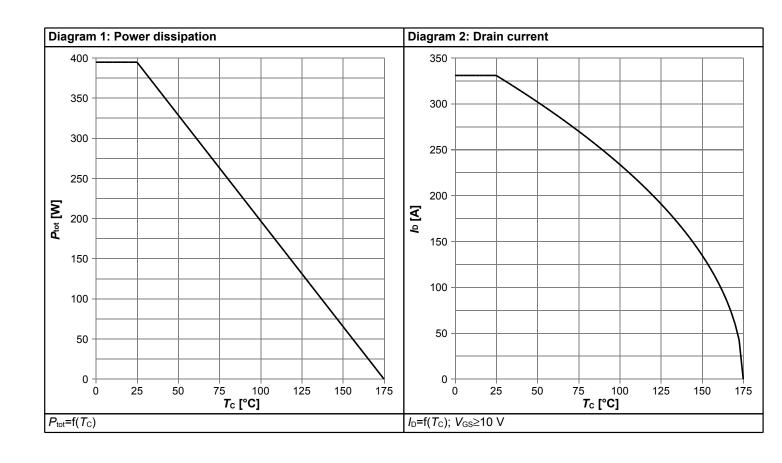


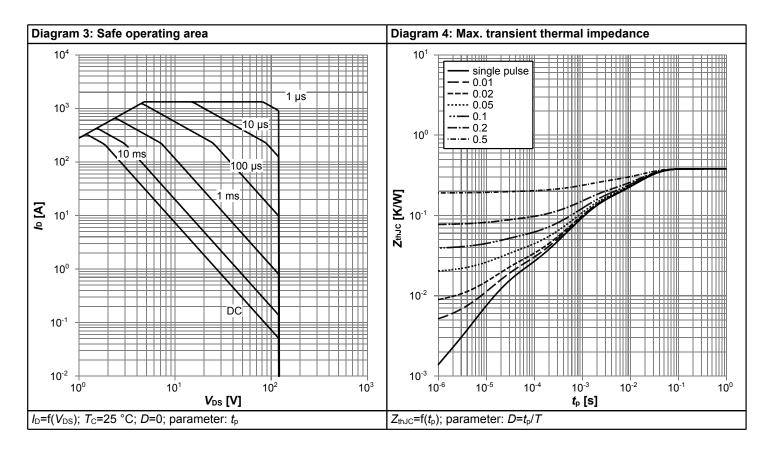
Table 7 Reverse diode

Demonstra	Comple ed		Values			Nata / Tank Oam difficu
Parameter	Symbol	Min.	Тур.	Max.	Unit	Note / Test Condition
Diode continuous forward current	Is	-	-	331	Α	T _C =25 °C
Diode pulse current	I _{S,pulse}	-	-	1324	Α	T _C =25 °C
Diode forward voltage	V _{SD}	-	0.87	1.0	V	V _{GS} =0 V, I _F =150 A, T _j =25 °C
Reverse recovery time ¹⁾	t _{rr}	-	45.5	91.0	ns	V _R =60 V, I _F =75 A, di _F /dt=300 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	132.3	264.6	nC	V _R =60 V, I _F =75 A, di _F /dt=300 A/μs
Reverse recovery time ¹⁾	t _{rr}	-	36.3	72.6	ns	V _R =60 V, I _F =75 A, di _F /dt=1000 A/μs
Reverse recovery charge ¹⁾	Q _{rr}	-	339.3	678.6	nC	V _R =60 V, I _F =75 A, d <i>i</i> _F /d <i>t</i> =1000 A/μs

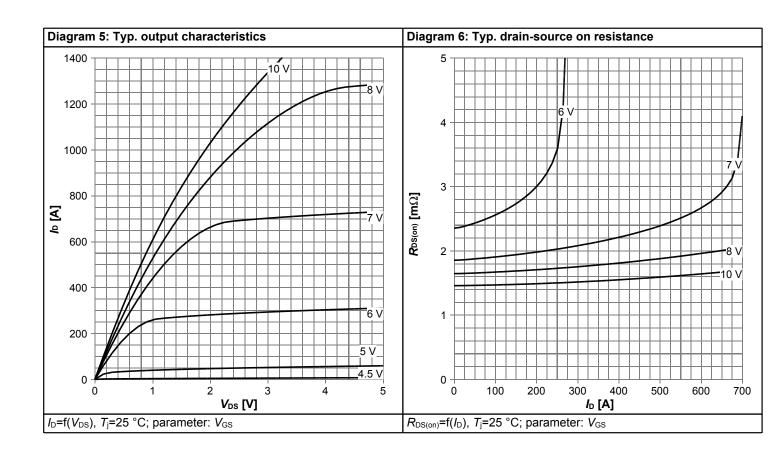


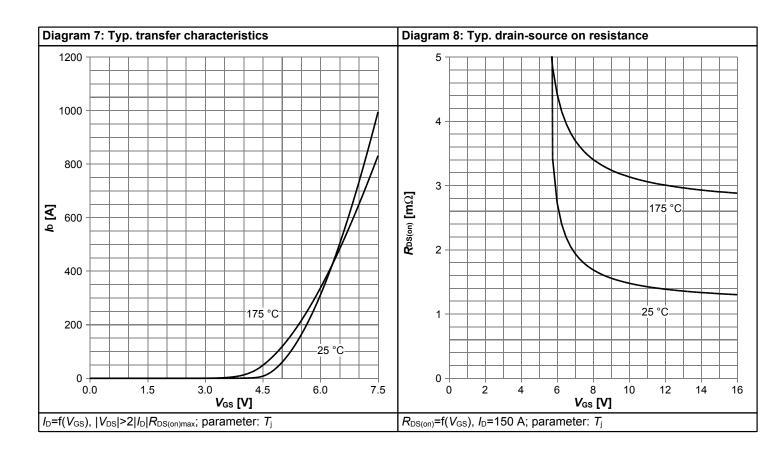
4 Electrical characteristics diagrams



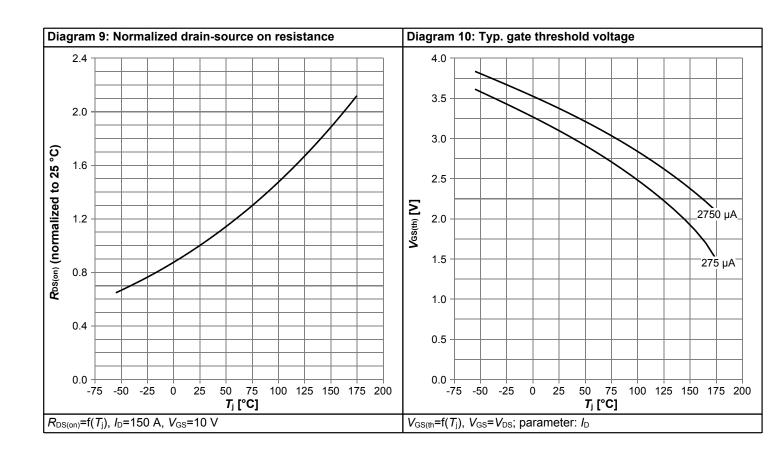


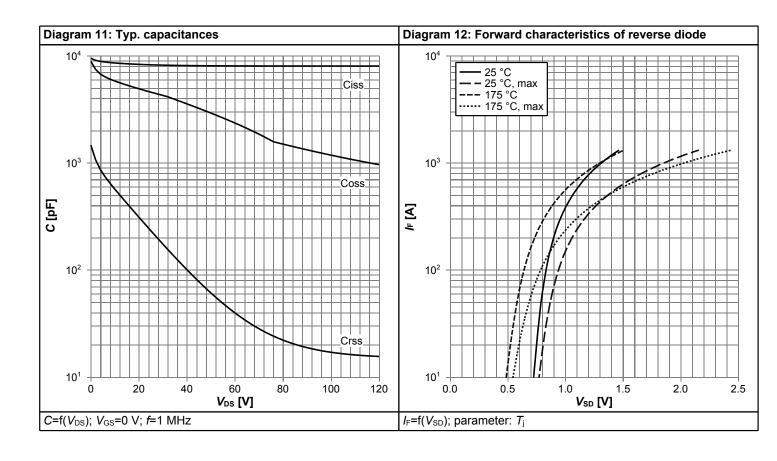




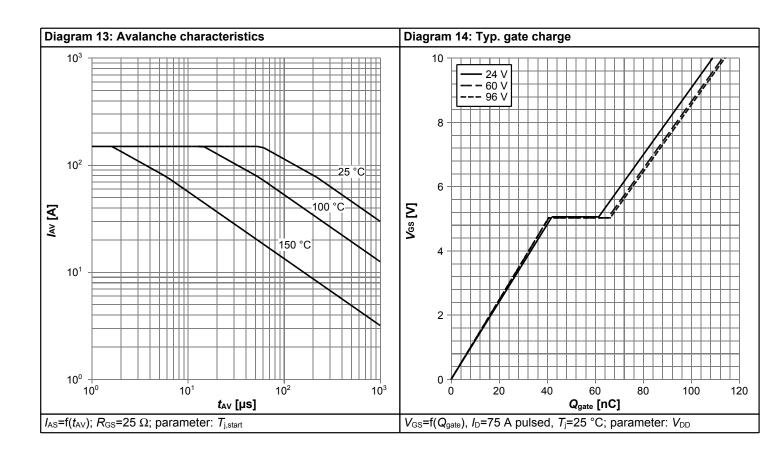


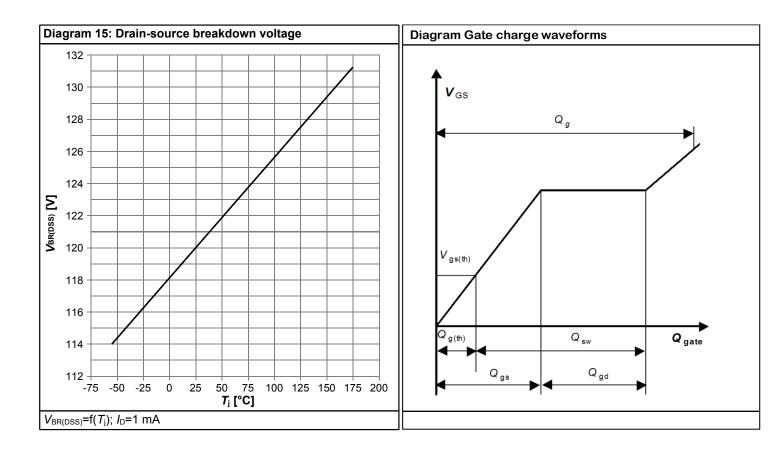






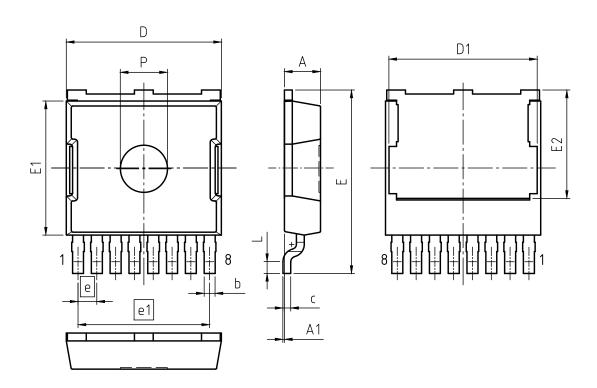








5 Package Outlines



PACKAGE - GROUP NUMBER:	PG-HSC	PG-HSOG-8-U01				
REVISION: 01	DATE	: 08.02.2021				
DIMENSIONS	MILLIN	IETERS				
DIMENSIONS	MIN.	MAX.				
Α	2.20	2.40				
A1	0.00	0.10				
b	0.60	0.80				
С	0.40	0.60				
D	9.70	10.10				
D1	9.36	9.56				
E	11.50	11.90				
E1	8.45	8.75				
E2	6.81	7.01				
е	1.20					
e1	8.	.40				
L	0.66	0.86				
P	2.90	3.10				

Figure 1 Outline PG-HSOG-8, dimensions in mm

OptiMOSTM 6 Power-Transistor, 120 V IPTG017N12NM6



Revision History

IPTG017N12NM6

Revision: 2023-10-12, Rev. 2.0

Previous Revision

Revision	Date	Subjects (major changes since last revision)			
2.0	2023-10-12	Release of final version			

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Final Data Sheet 11 Rev. 2.0, 2023-10-12